

Dual Non-Inverting Schmitt Trigger Buffer

MC74VHC2G17, MC74VHC2GT17

The MC74VHC2G17/MC74VHC2GT17 is a high performance dual buffer with Schmitt-Trigger inputs operating from a 2.0 to 5.5 V supply. The MC74VHC2G17 has CMOS-level input thresholds while the MC74VHC2GT17 has TTL-level input thresholds.

Features

- Designed for 2.0 V to 5.5 V V_{CC} Operation
- 4.0 ns t_{PD} at $V_{CC} = 5$ V (Typ)
- Inputs/Outputs Overvoltage Tolerant up to 5.5 V
- I_{OFF} Supports Partial Power Down Protection
- Sink 8 mA at 4.5 V
- Available in UDFN6 Package
- Chip Complexity < 100 FETs
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

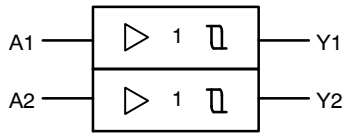
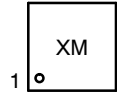


Figure 1. Logic Symbol

MARKING DIAGRAMS



UDFN6
1x1, 0.35P
CASE 517BX



X = Specific Device Code
M = Date Code*

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 7 of this data sheet.

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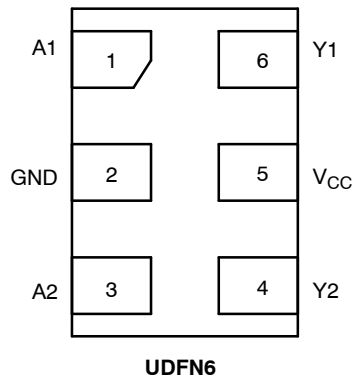


Figure 2. Pinout (Top View)

PIN ASSIGNMENT

Pin	Function
1	A1
2	GND
3	A2
4	Y2
5	V _{CC}
6	Y1

FUNCTION TABLE

A Input	Y Output
L	L
H	H

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MAXIMUM RATINGS

Symbol	Characteristics	Value	Units
V _{CC}	DC Supply Voltage	-0.5 to +6.5	V
V _{IN}	DC Input Voltage	-0.5 to +6.5	V
V _{OUT}	DC Output Voltage Active-Mode (High or Low State) SC-88, SC-74, UDFN6 Tri-State Mode (Note 1) Power-Down Mode (V _{CC} = 0 V)	-0.5 to V _{CC} +0.5 -0.5 to +6.5 -0.5 to +6.5	V
I _{IK}	DC Input Diode Current, V _{IN} < GND	-20	mA
I _{OK}	DC Output Diode Current, V _{OUT} < GND	-20	mA
I _{OUT}	DC Output Source/Sink Current	±25	mA
I _{CC} or I _{GND}	DC Supply Current per Supply Pin or Ground Pin	±50	mA
T _{STG}	Storage Temperature Range	-65 to +150	°C
T _L	Lead Temperature, 1 mm from Case for 10 secs	260	°C
T _J	Junction Temperature under Bias	+150	°C
θ _{JA}	Thermal Resistance (Note 2)	UDFN6 154	°C/W
P _D	Power Dissipation in Still Air	UDFN6 812	mW
MSL	Moisture Sensitivity	Level 1	-
F _R	Flameability Rating Oxygen Index: 28 to 34	UL 94-V-0 @ 0.125 in	-
V _{ESD}	ESD Withstand Voltage (Note 3)	Human Body Model Charged Device Model 2000 1000	V
I _{LATCHUP}	Latchup Performance (Note 4)	±100	mA

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Applicable to devices with outputs that may be tri-stated.
2. Measured with minimum pad spacing on an FR4 board, using 10 mm-by-1 inch, 2 ounce copper trace no air flow per JESD51-7.
3. HBM tested to ANSI/ESDA/JEDEC JS-001-2017. CDM tested to EIA/JESD22-C101-F. JEDEC recommends that ESD qualification to EIA/JESD22-A115-A (Machine Model) be discontinued per JEDEC/JEP172A.
4. Tested to EIA/JESD78 Class II.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min	Max	Unit
V _{CC}	Positive DC Supply Voltage	2.0	5.5	V
V _{IN}	DC Input Voltage	0	5.5	V
V _{OUT}	DC Output Voltage Active-Mode (High or Low State) Tri-State Mode (Note 1) Power-Down Mode (V _{CC} = 0 V)	0 0 0	V _{CC} 5.5 5.5	V
T _A	Operating Temperature Range	-55	+125	°C
t _r , t _f	Input Transition Rise or Fall Rate	V _{CC} = 2.0 V 0 0 0	No Limit No Limit No Limit No Limit	ns

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

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DC ELECTRICAL CHARACTERISTICS (MC74VHC2G17)

Symbol	Parameter	Test Conditions	V _{CC} (V)	T _A = 25 °C			-40 °C ≤ T _A ≤ 85 °C		-55 °C ≤ T _A ≤ 125 °C		Unit
				Min	Typ	Max	Min	Max	Min	Max	
V _{T+}	Positive Threshold Voltage		3.0	-	2.0	2.20	-	2.20	-	2.20	V
			4.5	-	3.0	3.15	-	3.15	-	3.15	
			5.5	-	3.6	3.85	-	3.85	-	3.85	
V _{T-}	Negative Threshold Voltage		3.0	0.9	1.5	-	0.9	-	0.9	-	V
			4.5	1.35	2.3	-	1.35	-	1.35	-	
			5.5	1.65	2.9	-	1.65	-	1.65	-	
V _H	Hysteresis Voltage		3.0	0.30	0.57	1.20	0.30	1.20	0.30	1.20	V
			4.5	0.40	0.67	1.40	0.40	1.40	0.40	1.40	
			5.5	0.50	0.74	1.60	0.50	1.60	0.50	1.60	
V _{OH}	High-Level Output Voltage	V _{IN} = V _{IH} or V _{IL}	2.0	1.9	2.0	-	1.9	-	1.9	-	V
		I _{OH} = -50 μA	3.0	2.9	3.0	-	2.9	-	2.9	-	
		I _{OH} = -50 μA	4.5	4.4	4.5	-	4.4	-	4.4	-	
		I _{OH} = -4 mA	3.0	2.58	-	-	2.48	-	2.34	-	
		I _{OH} = -8 mA	4.5	3.94	-	-	3.80	-	3.66	-	
V _{OL}	Low-Level Output Voltage	V _{IN} = V _{IH} or V _{IL}	2.0	-	0.0	0.1	-	0.1	-	0.1	V
		I _{OL} = 50 μA	3.0	-	0.0	0.1	-	0.1	-	0.1	
		I _{OL} = 50 μA	4.5	-	0.0	0.1	-	0.1	-	0.1	
		I _{OL} = 4 mA	3.0	-	-	0.36	-	0.44	-	0.52	
		I _{OL} = 8 mA	4.5	-	-	0.36	-	0.44	-	0.52	
I _{IN}	Input Leakage Current	V _{IN} = 5.5 V or GND	2.0 to 5.5	-	-	±0.1	-	±1.0	-	±1.0	μA
I _{OFF}	Power Off Leakage Current	V _{IN} = 5.5 V or V _{OUT} = 5.5 V	0	-	-	1.0	-	10	-	10	μA
I _{CC}	Quiescent Supply Current	V _{IN} = V _{CC} or GND	5.5	-	-	1.0	-	20	-	40	μA

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DC ELECTRICAL CHARACTERISTICS (MC74VHC2GT17)

Symbol	Parameter	Test Conditions	V _{CC} (V)	T _A = 25 °C			-40 °C ≤ T _A ≤ 85 °C		-55 °C ≤ T _A ≤ 125 °C		Unit
				Min	Typ	Max	Min	Max	Min	Max	
V _{T+}	Positive Threshold Voltage		3.0	-	1.40	1.60	-	1.6	-	1.6	V
			4.5	-	1.74	2.00	-	2.0	-	2.0	
			5.5	-	1.94	2.10	-	2.1	-	2.1	
V _{T-}	Negative Threshold Voltage		3.0	0.35	0.76	-	0.35	-	0.35	-	V
			4.5	0.5	1.01	-	0.5	-	0.5	-	
			5.5	0.6	1.13	-	0.6	-	0.6	-	
V _H	Hysteresis Voltage		3.0	0.30	0.64	1.20	0.30	1.20	0.30	1.20	V
			4.5	0.40	0.73	1.40	0.40	1.40	0.40	1.40	
			5.5	0.50	0.81	1.60	0.50	1.60	0.50	1.60	
V _{OH}	High-Level Output Voltage	V _{IN} = V _{IH} or V _{IL}	2.0	1.9	2.0	-	1.9	-	1.9	-	V
		I _{OH} = -50 μA	3.0	2.9	3.0	-	2.9	-	2.9	-	
		I _{OH} = -50 μA	4.5	4.4	4.5	-	4.4	-	4.4	-	
		I _{OH} = -4 mA	3.0	2.58	-	-	2.48	-	2.34	-	
		I _{OH} = -8 mA	4.5	3.94	-	-	3.80	-	3.66	-	
V _{OL}	Low-Level Output Voltage	V _{IN} = V _{IH} or V _{IL}	2.0	-	0.0	0.1	-	0.1	-	0.1	V
		I _{OL} = 50 μA	3.0	-	0.0	0.1	-	0.1	-	0.1	
		I _{OL} = 50 μA	4.5	-	0.0	0.1	-	0.1	-	0.1	
		I _{OL} = 4 mA	3.0	-	-	0.36	-	0.44	-	0.52	
		I _{OL} = 8 mA	4.5	-	-	0.36	-	0.44	-	0.52	
I _{IN}	Input Leakage Current	V _{IN} = 5.5 V or GND	2.0 to 5.5	-	-	±0.1	-	±1.0	-	±1.0	μA
I _{OFF}	Power Off Leakage Current	V _{IN} = 5.5 V or V _{OUT} = 5.5 V	0	-	-	1.0	-	10	-	10	μA
I _{CC}	Quiescent Supply Current	V _{IN} = V _{CC} or GND	5.5	-	-	1.0	-	20	-	40	μA
I _{CC(T)}	Increase in Quiescent Supply Current per Input Pin	One Input: V _{IN} = 3.4 V; Other Input at V _{CC} or GND	5.5	-	-	1.35	-	1.5	-	1.65	mA

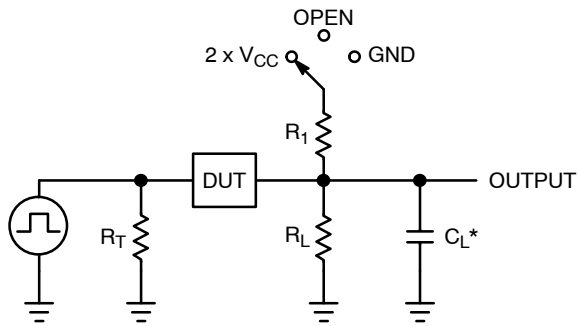
AC ELECTRICAL CHARACTERISTICS

Symbol	Parameter	Conditions	V _{CC} (V)	T _A = 25 °C			-40 °C ≤ T _A ≤ 85 °C		-55 °C ≤ T _A ≤ 125 °C		Unit
				Min	Typ	Max	Min	Max	Min	Max	
t _{PLH} , t _{PHL}	Propagation Delay, A to Y (Figures 3 and 4)	C _L = 15 pF	3.0 to 3.6	-	7.0	12.8	-	15.0	-	17.0	ns
				-	8.5	16.3	-	18.5	-	20.5	
		C _L = 50 pF	4.5 to 5.5	-	4.0	8.6	-	10.0	-	11.5	
				-	5.5	10.6	-	12.0	-	13.5	
C _{IN}	Input Capacitance			-	4.0	10	-	10	-	10	pF
C _{OUT}	Output Capacitance	Output in High Impedance State		-	6.0	-	-	-	-	-	pF

C _{PD}	Power Dissipation Capacitance (Note 5)	Typical @ 25 °C, V_{CC} = 5.0 V	pF
		8.0	

5. C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation: I_{CC(OPR)} = C_{PD} • V_{CC} • f_{in} + I_{CC}. C_{PD} is used to determine the no-load dynamic power consumption; P_D = C_{PD} • V_{CC}² • f_{in} + I_{CC} • V_{CC}.

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C_L includes probe and jig capacitance
 R_T is Z_{OUT} of pulse generator (typically 50 Ω)
 $f = 1$ MHz

Figure 3. Test Circuit

Test	Switch Position	C_L , pF	R_L , Ω
t_{PLH} / t_{PHL}	Open	See AC Characteristics Table	X
t_{PLZ} / t_{PZL}	V_{CC}		1 k
t_{PHZ} / t_{PZH}	GND		1 k

X = Don't Care

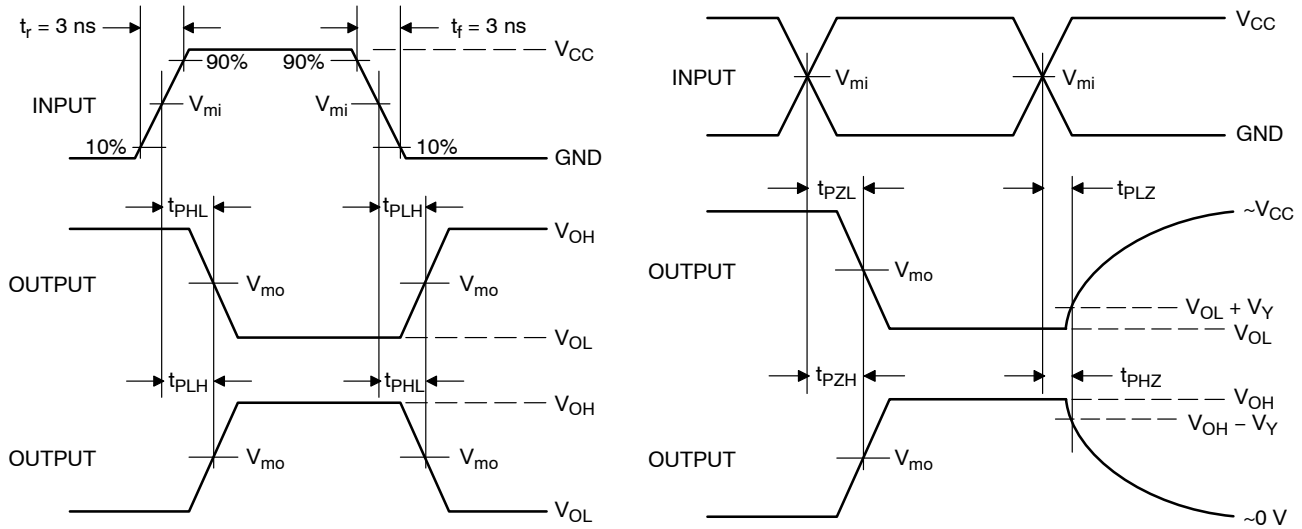


Figure 4. Switching Waveforms

V_{CC} , V	V_{mi} , V	V_{mo} , V		V_Y , V
		t_{PLH} , t_{PHL}	t_{PZL} , t_{PLZ} , t_{PZH} , t_{PHZ}	
3.0 to 3.6	$V_{CC} / 2$	$V_{CC} / 2$	$V_{CC} / 2$	0.3
4.5 to 5.5	$V_{CC} / 2$	$V_{CC} / 2$	$V_{CC} / 2$	0.3

MC74VHC2G17, MC74VHC2GT17

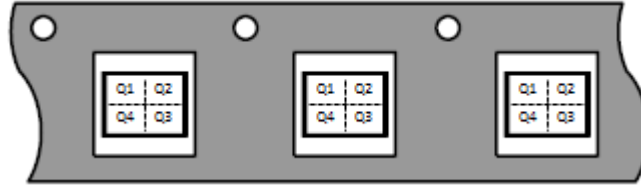
ORDERING INFORMATION

Device	Package	Specific Device Code	Pin1 Orientation (See below)	Shipping [†]
MC74VHC2G17MU3TCG	UDFN6, 1.0 x 1.0, 0.35P	5 (Rotated 90° CW)	Q4	3000 / Tape & Reel

[†] For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, [BRD8011/D](#).

PIN 1 ORIENTATION IN TAPE AND REEL

Direction of Feed

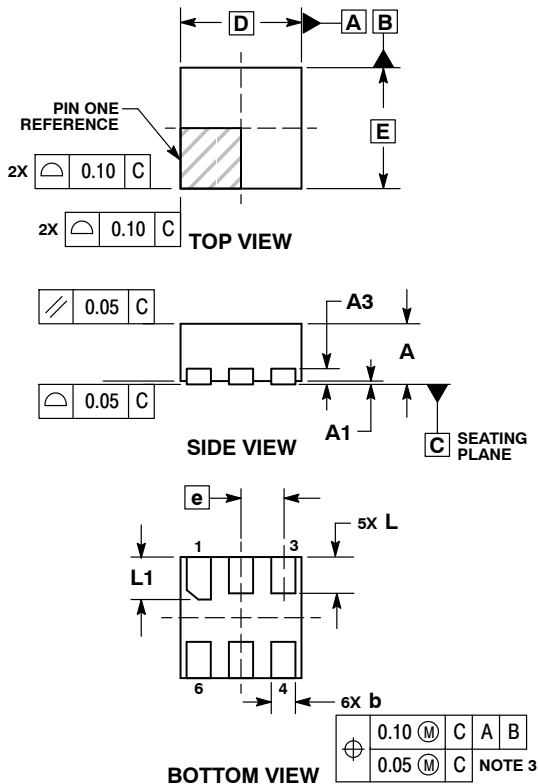




UDFN6, 1x1, 0.35P
CASE 517BX
ISSUE O

SCALE 4:1

DATE 18 MAY 2011

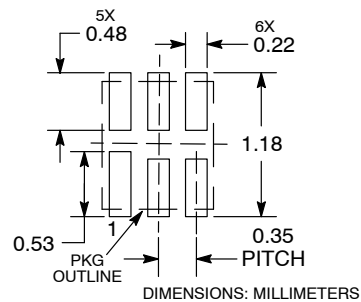


NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.20 MM FROM TERMINAL TIP.
4. PACKAGE DIMENSIONS EXCLUSIVE OF BURRS AND MOLD FLASH.

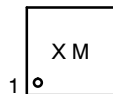
MILLIMETERS		
DIM	MIN	MAX
A	0.45	0.55
A1	0.00	0.05
A3	0.13	REF
b	0.12	0.22
D	1.00	BSC
E	1.00	BSC
e	0.35	BSC
L	0.25	0.35
L1	0.30	0.40

RECOMMENDED
SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

GENERIC
MARKING DIAGRAM*



X = Specific Device Code
M = Date Code

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present. Some products may not follow the Generic Marking.

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